imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China





The Future of Analog IC Technology

DESCRIPTION

The MP18021A is a high-frequency, 100V, half bridge, N-channel power MOSFET driver. Its low side and high side driver channels are independently controlled and matched with a time delay of less than 5ns. Under-voltage lockout on both high side and low side supplies force their outputs low in case of insufficient supply. The integrated bootstrap diode reduces external component count.

FEATURES

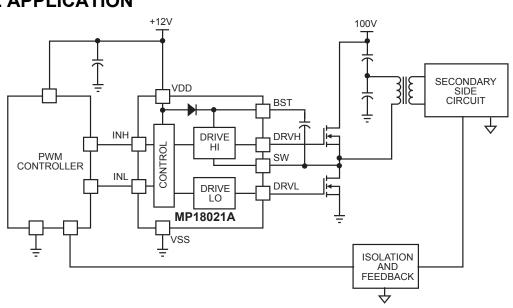
- Drives N-Channel MOSFET Half Bridge
- 100V V_{BST} Voltage Range
- On-Chip Bootstrap Diode
- Typical 16ns Propagation Delay Time
- Less Than 5ns Gate Drive Matching
- Drives 1nf Load with 12ns/9ns Rise/Fall Times with 12V VDD
- TTL Compatible Input
- Less Than 150µA Quiescent Current
- UVLO for Both High Side and Low Side
- In SOIC8E and QFN8 (3×3mm) Packages

APPLICATIONS

- Telecom Half Bridge Power Supplies
- Avionics DC-DC Converters
- Two-Switch Forward Converters
- Active Clamp Forward Converters

All MPS parts are lead-free, halogen free, and adhere to the RoHS directive. For MPS green status, please visit MPS website under Quality Assurance.

"MPS" and "The Future of Analog IC Technology" are Registered Trademarks of Monolithic Power Systems, Inc.



TYPICAL APPLICATION

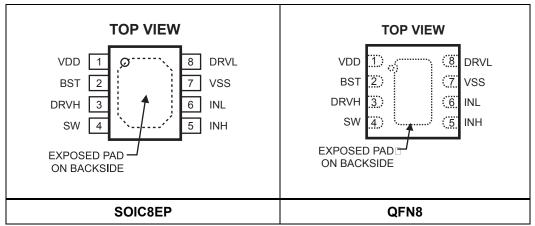


ORDERING INFORMATION

Part Number	Package	Top Marking
MP18021HN-A*	SOIC8E	MP18021A
MP18021HQ-A**	QFN8 (3x3mm)	ACP

* For Tape & Reel, add suffix –Z (e.g. MP18021HN–A–Z);
For RoHS compliant packaging, add suffix –LF (e.g. MP18021HN–A–LF–Z)
** For Tape & Reel, add suffix –Z (e.g. MP18021HQ–A–Z);
For RoHS compliant packaging, add suffix –LF (e.g. MP18021HQ–A–LF–Z)

PACKAGE REFERENCE



ABSOLUTE MAXIMUM RATINGS (1)

Supply Voltage (V _{DD}) SW Voltage (V _{SW}) BST Voltage (V _{BST}) BST to SW	$\begin{array}{c}5.0V \text{ to } +105V \\0.3V \text{ to } +120V \\0.3V \text{ to } +120V \\0.3V \text{ to } +18V \\ 8ST-SW) + 0.3V \\ to (VDD + 0.3V) \\ to (VDD + 0.3V) \\ (T_A = 25^{\circ}\text{C})^{(2)} \\26W \\26W \\25W \end{array}$
Continuous Power Dissipation SOIC8E	(T _A =100°C) ⁽²⁾ 0.52W
QFN8 (3x3mm)	
Junction Temperature	
Lead Temperature	260°C
Storage Temperature	65°C to +150°C

Recommended Operating Conditions ⁽³⁾

Supply Voltage (VDD	9.0V to 18V
	-1.0V to +100V
SW slew rate	<50V/nsec
Operating Junction 1	emp. (T _J)40°C to +125°C

Thermal Resistance θJA θJC SOIC8E 48 10... °C/W QFN8 (3x3mm) 50 12... °C/W

Notes:

- 1) Exceeding these ratings may damage the device.
- 2) The maximum allowable power dissipation is a function of the maximum junction temperature T_J(MAX), the junction-to-ambient thermal resistance θ_{JA}, and the ambient temperature T_A. The maximum allowable continuous power dissipation at any ambient temperature is calculated by P_D(MAX)=(T_J(MAX)-T_A)/ θ_{JA}. Exceeding the maximum allowable power dissipation will cause excessive die temperature, and the regulator will go into thermal shutdown. Internal thermal shutdown circuitry protects the device from permanent damage.
- The device is not guaranteed to function outside of its operating conditions.
- 4) Measured on JESD51-7, 4-layer PCB.



ELECTRICAL CHARACTERISTICS

$V_{DD} = V_{BST}-V_{SW}=12V$, $V_{SS}=V_{SW}=0V$, No load at DRVH and DRVL, $T_A=25^{\circ}C$, unless otherwise noted.

Parameter	Symbol	Condition	Min	Тур	Max	Units
Supply Currents						
VDD quiescent current		INL=INH=0		100	150	μA
VDD operating current	I _{DDO}	f _{sw} =500kHz		2.8	3.5	mA
Floating driver quiescent current	I _{BSTQ}	INL=INH=0		60	90	μA
Floating driver operating current	I _{BSTO}	f _{sw} =500kHz		2.1	3	mA
Leakage Current	I _{LK}	BST=SW=100V		0.05	1	μA
Inputs						
INL/INH High				2	2.4	V
INL/INH Low			1	1.4		V
INL/INH internal pull-down resistance	R _{IN}			185		kΩ
Under Voltage Protection						
VDD rising threshold	V_{DDR}		7.7	8.1	8.5	V
VDD hysteresis	V _{DDH}			0.5		V
(BST-SW) rising threshold	V _{BSTR}		6.7	7.1	7.5	V
(BST-SW) hysteresis	V _{BSTH}			0.55		V
Bootstrap Diode	Donn					
Bootstrap diode VF @ 100uA	V _{F1}			0.5		V
Bootstrap diode VF @ 100mA	V _{F2}			0.9		V
Bootstrap diode dynamic R	R _D	@ 100mA		2.5		Ω
Low Side Gate Driver						
Low level output voltage	V _{OLL}	I ₀ =100mA		0.15	0.22	V
High level output voltage to rail	V _{OHL}	I _o =-100mA		0.45	0.6	V
Peak pull-up current	I _{OHL}	V _{DRVL} =0V, V _{DD} =12V		1.5		А
Peak puil-up cuitent		V _{DRVL} =0V, V _{DD} =16V		2.5		А
Peak pull-down current	I _{OLL}	V _{DRVL} =V _{DD} =12V		2.5		А
Peak puil-down current		V _{DRVL} =V _{DD} =16V		3.5		Α
Floating Gate Driver						
Low level output voltage	V_{OLH}	I _o =100mA		0.15	0.22	V
High level output voltage to rail V _o		I _o =-100mA		0.45	0.6	V
	I _{онн}	$V_{DRVH}=0V, V_{DD}=12V$		1.5		Α
Peak pull-up current		V _{DRVH} =0V, V _{DD} =16V		2.5		Α
Peak pull-down current	I _{OLH}	V _{DRVH} =V _{DD} =12V		2.5		А
r eak puil-uown current		V _{DRVH} =V _{DD} =16V		3.5		Α



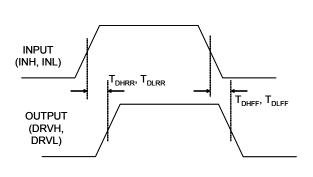
ELECTRICAL CHARACTERISTICS (continued)

$V_{DD} = V_{BST}-V_{SW}=12V$, $V_{SS}=V_{SW}=0V$, No load at DRVH and DRVL, $T_A=25^{\circ}C$, unless otherwise noted.

Parameter	Symbol	Condition	Min	Тур	Max	Units	
Switching Spec Low Side Ga	te Driver				-	•	
Turn-off propagation delay INL falling to DRVL falling	T_{DLFF}			16		ns	
Turn-on propagation delay INL rising to DRVL rising	T _{DLRR}			16			
DRVL rise time		C _L =1nF		12		ns	
DRVL fall time		C _L =1nF		9		ns	
Switching Spec Floating Gat	e Driver						
Turn-off propagation delay INL falling to DRVH falling	T_{DHFF}			16		ns	
Turn-on propagation delay INL rising to DRVH rising	T _{DHRR}			16		ns	
DRVH rise time		C _L =1nF		12		ns	
DRVH fall time		C _L =1nF		9		ns	
Switching Spec Matching							
Floating driver turn-off to low side drive turn-on	T _{MON}			1	5	ns	
Low side driver turn-off to floating driver turn-on	T _{MOFF}			1	5	ns	
Minimum input pulse width that changes the output	T _{PW}				50 ⁽⁵⁾	ns	
Bootstrap diode turn-on or turn-off time	T _{BS}			10 ⁽⁵⁾		ns	
Over Temperature Protection ⁽⁵⁾							
OTP entry threshold				160			
OTP recovery threshold				140		°C	
OTP hysteresis				20		7	

Note:

5) Derived from bench characterization. Not tested in production.



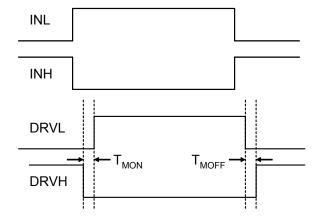


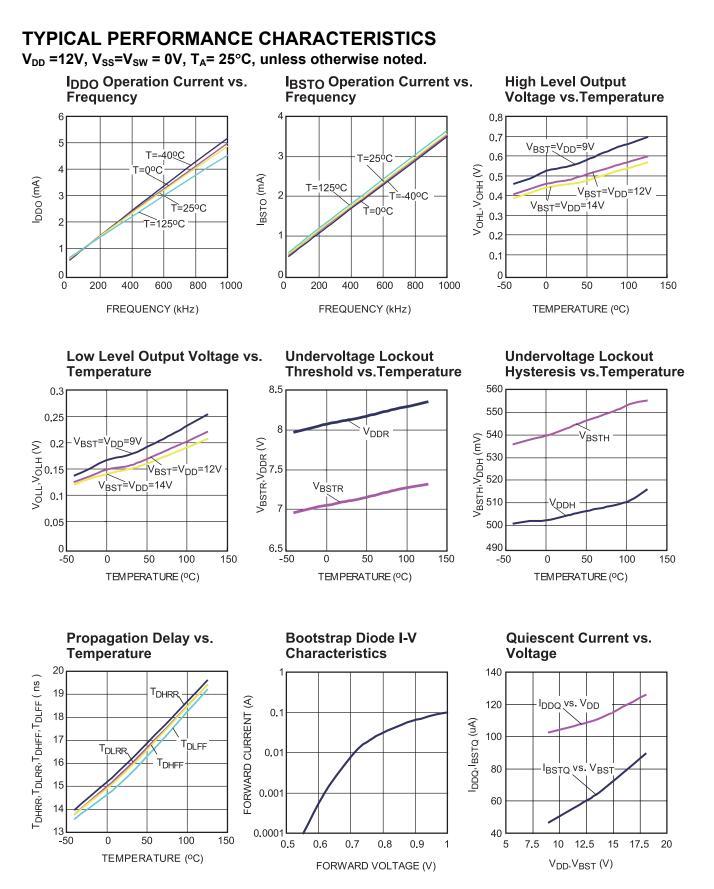
Figure 1—Timing Diagram



PIN FUNCTIONS

Pin #	Name	Description
1	VDD	Supply input. This pin supplies power to all the internal circuitry. A decoupling capacitor to ground must be placed close to this pin to ensure stable and clean supply.
2	BST	Bootstrap. This is the positive power supply for the internal floating high-side MOSFET driver. Connect a bypass capacitor between this pin and SW pin.
3	DRVH	Floating driver output.
4	SW	Switching node.
5	INH	Control signal input for the floating driver.
6	INL	Control signal input for the low side driver.
7	VSS, Exposed Pad	Chip ground. Connect exposed pad to VSS for proper thermal operation.
8	DRVL	Low side driver output.





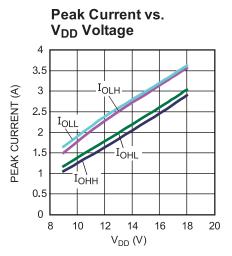
MP18021A Rev. 1.53 10/20/2015 MF

3 www.MonolithicPower.com MPS Proprietary Information. Patent Protected. Unauthorized Photocopy and Duplication Prohibited. © 2015 MPS. All Rights Reserved.



TYPICAL PERFORMANCE CHARACTERISTICS (continued)

 V_{DD} =12V, V_{SS} = V_{SW} = 0V, T_A = 25°C, unless otherwise noted.

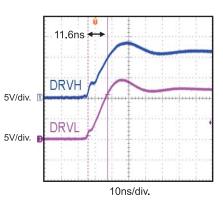


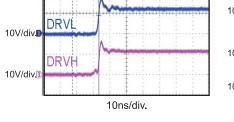
Turn-on Propagation Delay

Gate Drive Matching TMOFF

INH - 0.96ns 10V/div. 1 10V/div. 2 DRVH 10V/div. DRVL 10V/div. 4ns/div.

Drive Rise Time (1nF Load)





16.0ns

INH:

INL

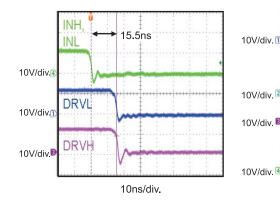
10V/div.

Turn-off Propagation Delay



-0.64ns

Drive Fall Time (1nF Load)





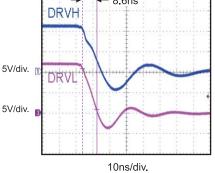
4ns/div.

INH

DRVH

DRVL







BLOCK DIAGRAM

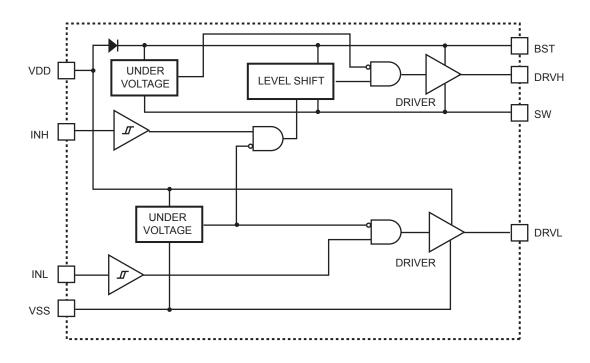
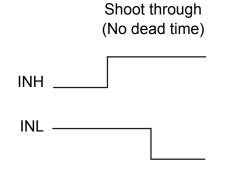


Figure 2—Function Block Diagram

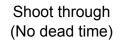


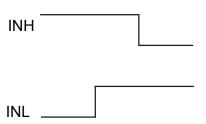
APPLICATION

The input signals of INH and INL can be controlled independently. If both INH and INL are controlling HSFET and LSFET of the same bridge, then users must avoid shoot through by

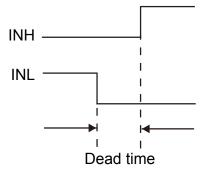


setting sufficient dead time between INH and INL low, and vice versa. See below figure. Dead time is defined as the time internal between INH low and INL low.

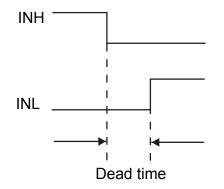




No Shoot through



No Shoot through





REFERENCE DESIGN CIRCUITS

Half Bridge Converter

In half-bridge converter topology, the MOSFETs are driven alternately with some dead time. Therefore, INH and INL are driven with

alternating signals from the PWM controller. The input voltage can be up to 100V in this application.

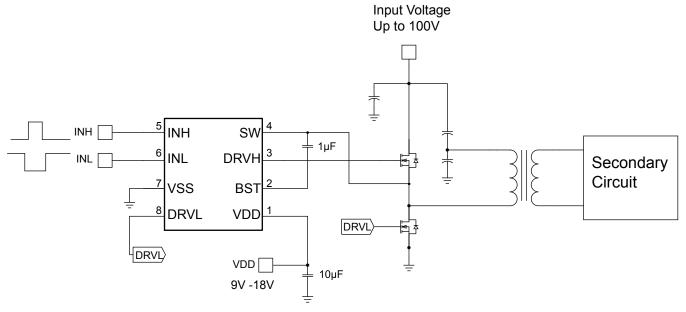
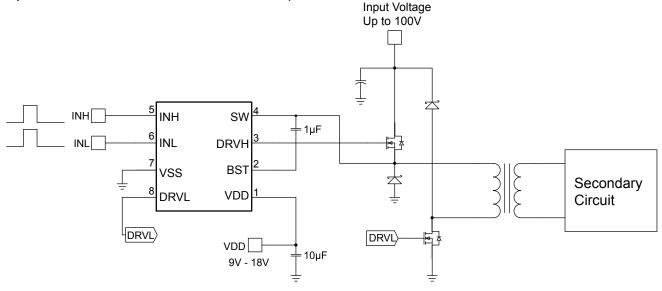


Figure 3 – Half Bridge Converter

Two-Switch Forward Converter

In two-switch forward converter topology, both MOSFETs are turned on and off together. The input signal (INH and INL) comes from the PWM controller, which senses the output voltage (and output current if current-mode control is used).

The Schottky diodes clamp the reverse swing of the power transformer and must be rated at the input voltage. The input voltage can be up to 100V in this circuit.







Active-Clamp Forward Converter

In active-clamp forward converter topology, the MOSFETs are driven alternately. The high-side MOSFET, along with capacitor C_{reset} , is used to reset the power transformer in a lossless manner.

This topology lends itself well to run at duty cycles exceeding 50%. For these reasons, the input voltage may not be able to run at 100V for this application.

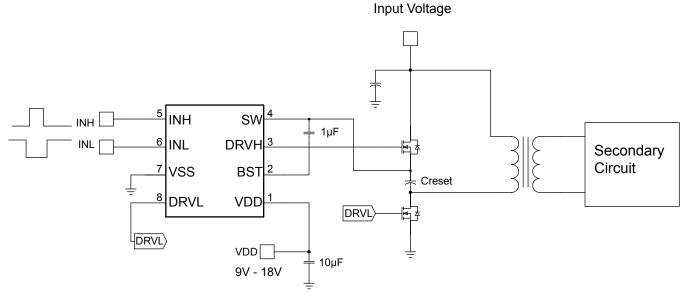
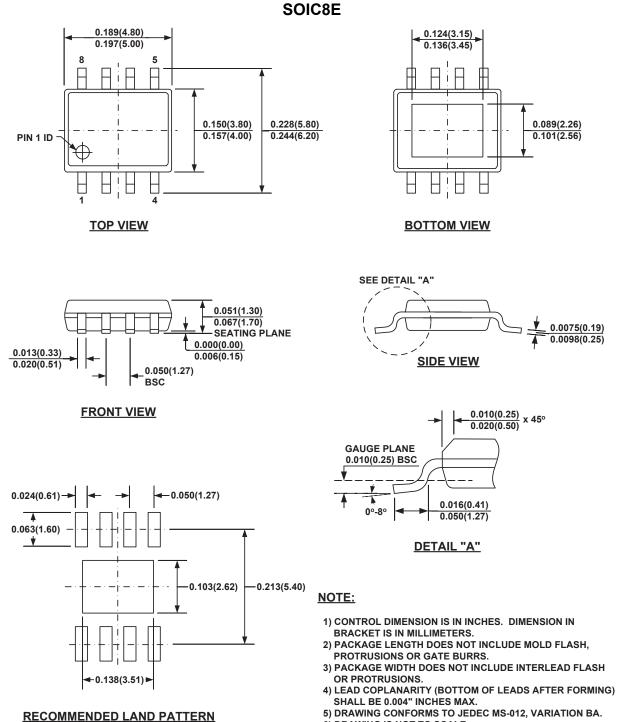


Figure 5 – Active-Clamp Forward Converter



PACKAGE INFORMATION



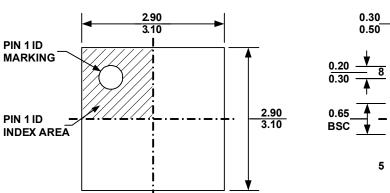
5) DRAWING CONFORMS TO JEDEC MS-012, VARIATION BA. 6) DRAWING IS NOT TO SCALE.

0.0075(0.19)

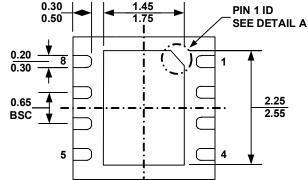
0.0098(0.25)



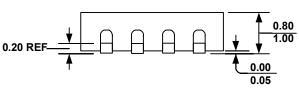
QFN8 (3×3mm)



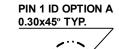
TOP VIEW

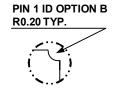


BOTTOM VIEW

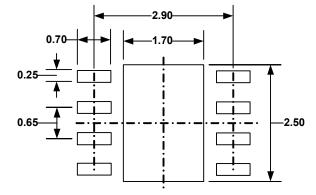


SIDE VIEW





DETAIL A



<u>NOTE:</u>

1) ALL DIMENSIONS ARE IN MILLIMETERS

2) EXPOSED PADDLE SIZE DOES NOT INCLUDE MOLD FLASH 3) LEAD COPLANARITY SHALL BED.10 MILLIMETER MAX 4) DRAWING CONFORMS TO JEDEC MO229, VARIATION VEEC-2. 5) DRAWING IS NOT TO SCALE

RECOMMENDED LAND PATTERN

NOTICE: The information in this document is subject to change without notice. Users should warrant and guarantee that third party Intellectual Property rights are not infringed upon when integrating MPS products into any application. MPS will not assume any legal responsibility for any said applications.